

Electronic Acknowledgement Receipt

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International Application Number:	
Confirmation Number:	8571
Title of Invention:	System and method for sharing confidential semiconductor manufacturing information using transitory links
First Named Inventor/Applicant Name:	Cheng-Hui Chiu
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Amendment - After Non-Final Rejection	85Response.pdf	313777	no	9

Warnings:

Information:	Total Files Size (in bytes):	313777
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National Stage of an International Application under 35 U.S.C. 371 If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.		